

NOTES: UNITS IN MILLIMETERS UNLESS OTHERWISE SPECIFIED INTERPRET THIS DRAWING IN ACCORDANCE WITH IPC-D-325A 2. BOARD FABRICATION AND QUALITY PER IPC-6012, CLASS 2, EXCEPT SPECIFIED HEREIN 3. MUST COMPLY WITH EUROPEAN DIRECTIVE 2002/95/EC (RoHS) 4. DIMENSIONAL LIMITS APPLY AFTER PLATING OR COATING 5. BOW AND TWIST MAXIMUM IS 0.75% MATERIAL: LAMINATE AND PREPREG SHALL BE IN ACCORDANCE WITH IPC-4101/21. 170 DEGREES CELSIUS MINIMUM Tg, UL 94V-0 7. STACKUP SUMMARY: A. NUMBER OF COPPER LAYERS: 4 B. BOARD THICKNESS SHALL BE 62mil +/- 10% C. COPPER: See Layer Stack D. DEFAULT TRACE/SPACE: 6mil / 6mil E. CONDUCTOR WIDTH TOLERANCE = +/- 0.01mm 8. SURFACE FINISH/PLATING: A. BOARD SHALL BE IMMERSION GOLD PLATED (ENIG) ACCORDING TO IPC-4552. THICKNESS SHALL BE A MINIMUM OF 0.05 µm GOLD OVER 3-6 µm NICKEL 9. SOLDERMASK WITH LIQUID PHOTO IMAGEABLE (LPI) PER IPC-SM-840C, CLASS T. COLOR: MATTE BLACK 10. SILKSCREEN PER SUPPLIED ARTWORK WITH ORGANIC, NON-CONDUCTIVE, EPOXY INK. SILKSCREEN MAY BE TRIMMED OFF ANY SOLDERABLE ENTITY. COLOR: WHITE 11. 100% BARE BOARD ELECTRICAL TEST TO BE DONE WITH REFERENCE TO SUPPLIED **NETLIST** 12. LOCATE MANUFACTURER'S IDENTIFICATION AND LOT CODE ON PRIMARY SIDE FREE FROM ALL METAL ENTITY RENDERED IN SILKSCREEN. 13. DETAILS NOT SPECIFIED ARE AT MANUFACTURER'S OPTION BUT FINAL APPROVAL MUST BE OBTAINED



